

# **FPN330** FPN330A



## **NPN Low Saturation Transistor**

These devices are designed for high current gain and low saturation voltage with collector currents up to 3.0 A continuous. Sourced from Process NB.

## **Absolute Maximum Ratings\***

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units 000
V <sub>CEO</sub>	Collector-Emitter Voltage	30	V
V <sub>CBO</sub>	Collector-Base Voltage	50	V
V <sub>EBO</sub>	Emitter-Base Voltage	5.0	V
Ic	Collector Current - Continuous	3.0	A
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

1) These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

#### **Thermal Characteristics** TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units	
	- 4-7 (DO) W	FPN330 / FPN330A		
P <sub>D</sub>	Total Device Dissipation	1.0	W	
R <sub>θJC</sub>	Thermal Resistance, Junction to Case	50	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	125	°C/W	



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TA = 25°C unless otherwise noted

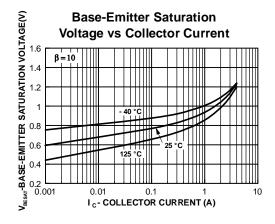
Symbol	Parameter	Test Conditions	Min	Max	Units
OFF CHA	RACTERISTICS				
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	$I_C = 10 \text{ mA}, I_B = 0$	30		V
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	$I_C = 100  \mu A,  I_E = 0$	50		V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = 100  \mu A,  I_C = 0$	5.0		V
I <sub>CBO</sub>	Collector Cutoff Current	V <sub>CB</sub> = 30 V, I <sub>E</sub> = 0 V <sub>CB</sub> = 30 V, I <sub>E</sub> = 0, T <sub>A</sub> = 100°C		100 10	nA μA
I <sub>EBO</sub>	Emitter Cutoff Current	$V_{CB} = 30 \text{ V}, I_{E} = 0, T_{A} = 100^{\circ}\text{C}$ $V_{EB} = 4.0 \text{ V}, I_{C} = 0$		100	nA
		330. I <sub>C</sub> = 1.0 A, V <sub>CE</sub> = 2.0 V I <sub>C</sub> = 2.0 A, V <sub>CE</sub> = 2.0 V	A 250 120 50		
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	$I_C = 2.0 \text{ A}, V_{CE} = 2.0 \text{ V}$ $I_C = 1.0 \text{ A}, I_B = 100 \text{ mA}$ 330		500 450	mV mV
		$I_C = 2.0 \text{ A}, I_B = 200 \text{ mA}$		1.0	V
$V_{BE(sat)}$	Base-Emitter Saturation Voltage	$I_C = 1.0 \text{ A}, I_B = 100 \text{ mA}$		1.25	V
V <sub>BE(on)</sub>	Base-Emitter Saturation Voltage	$I_C = 1.0 \text{ A}, V_{CE} = 2.0 \text{ V}$		1.0	V
SMALL SI	GNAL CHARACTERISTICS Output Capacitance	V <sub>CB</sub> = 10 V, I <sub>F</sub> = 0, f = 1.0 MHz		30	pF
F <sub>T</sub>	Transition Frequency	$I_C = 100 \text{ mA}, V_{CE} = 5.0 \text{ V},$	100	- 55	MHz
rt	Transition Frequency	f = 100 MHz	100		IVITIZ

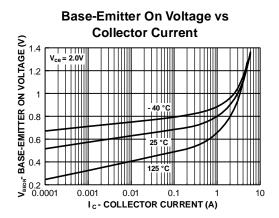
<sup>\*</sup>Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%

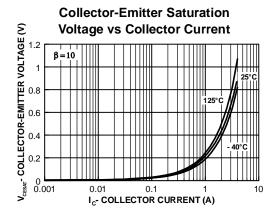
## **NPN Low Saturation Transistor**

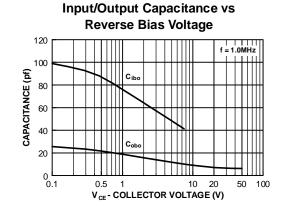
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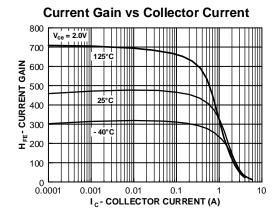
## **Typical Characteristics**

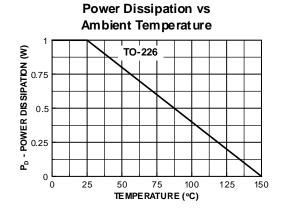












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